imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

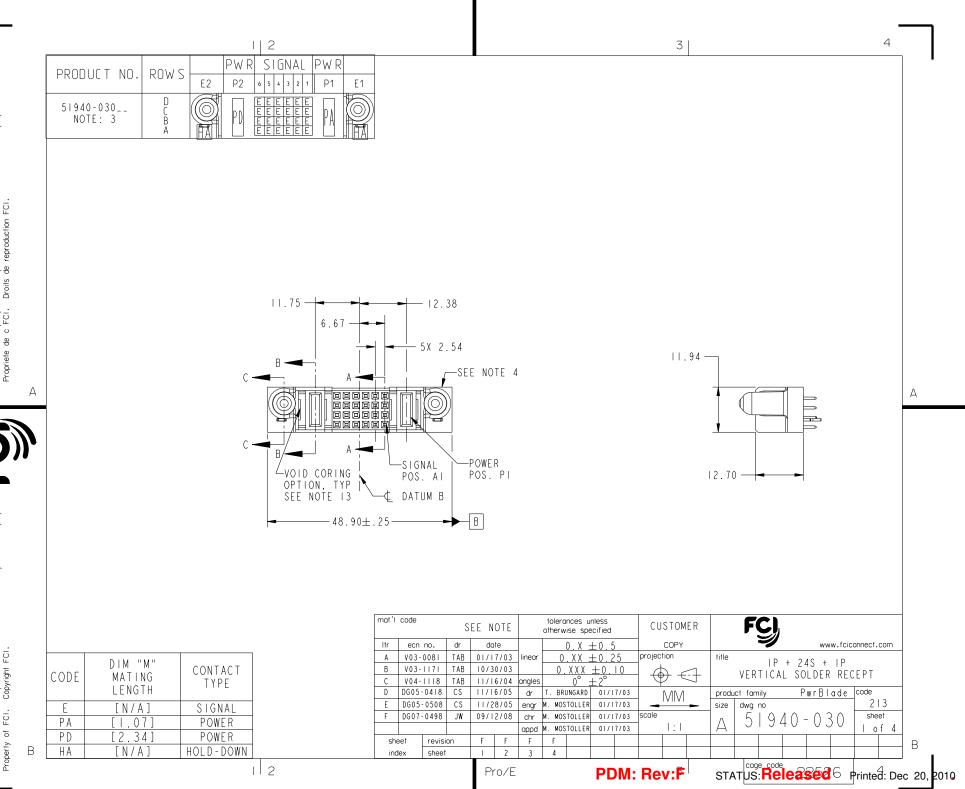
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

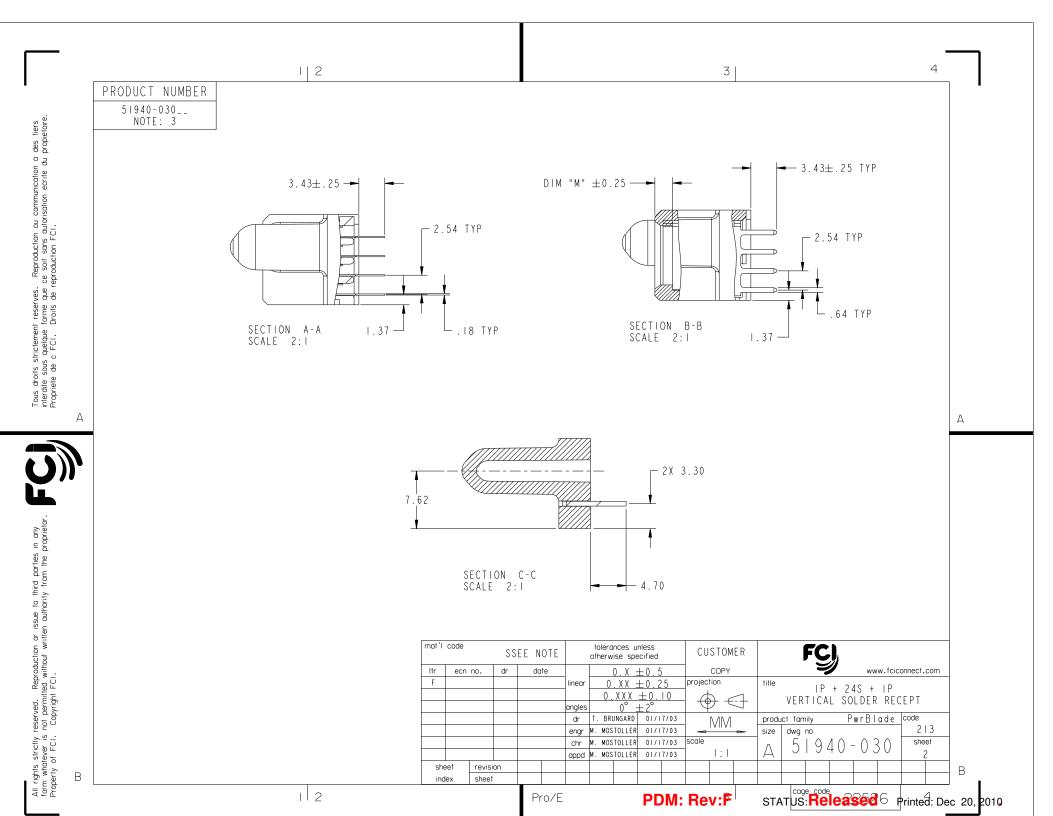
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

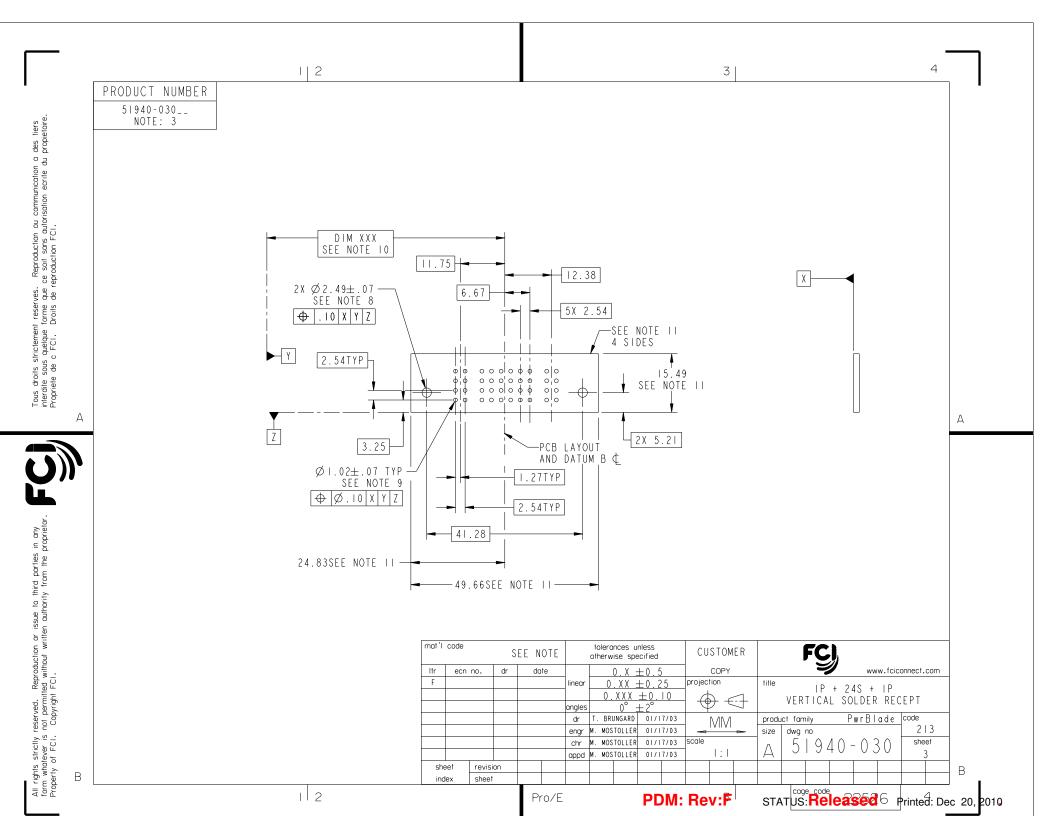




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	2			3		4
PRODUCT NUMBER 51940-030 NOTE: 3			•	I		
NOTES: I. DIMENSIONS AND TOLERANCES ARE ASME YI4.5M, 1994 UNLESS OTHE CONNECTOR NOTES: (2) HOUSING MATERIAL: UL 94 V-0 V HIGH-TEMP THERMOPLASTIC POWER CONTACT MATERIAL: COPPE	RWISE SPECIFIED. GLASS FILLED R ALLOY					
SIGNAL PIN MATERIAL: COPPE	3 FOR PLATING SPEC OF 5	,	F PRESPECTIVELY			
THIS SURFACE. 5. PRODUCT SPECIFICATION GS-12-1 APPLICATION SPECIFICATION BUS	49.					
6. PACKAGED IN TRAYS. PCB NOTES: 7. ALL HOLE DIAMETERS ARE FINISH	ED HOLE SIZE.					,
8 MOUNTING HOLES, WHERE APPLIC 9 Ø1.151±0.025 DRILLED HOLES						
0.008 MIN SnPb OR Sn OVER 0. TO 0.08 Cu PLATING TO ACHIEV Ø1.02±.07 HOLE.						
(10) "DIM XXX" TO BE DETERMINED B (11) CONNECTOR KEEP-OUT ZONE.	′THE CUSTOMER.					
12 A A SYMBOL WILL BE NEXT TO AN VIEW, OR NOTE WHICH HAS BEEN THE CURRENT DRAWING REVISION.	MODIFIED WITH					
I3. THE VOID CORING IN BETWEEN PC MODULES AND END MODULES ARE C MAY BE DIFFERENT FOR OPTIMIZI THE VOID CORING WILL NOT EFFE	PTIONAL AND THE SHAPE NG THE MODING PROCESS.	ltr ecn no, dr	EE NOTE toleronces unless otherwise specifie date 0.X ± 0 linear 0.XX ± 0	.5 CUSTOMER	FGJ www.fcicor	
			$\begin{array}{c c} 0.XXX \pm 0\\ \hline 0 \text{ ongles} & 0^{\circ} \pm 2^{\circ}\\ \hline dr & T. BRUNGARD & 01\\ \hline \end{array}$	117/03 MM	IP + 24S + IP VERTICAL SOLDER RECE product family PwrBlade c size dwg no	
		sheet revision index sheet	chr M. MOSTOLLER 01	/17/03 Scole	A 51940-030	sheet 4
	1 2	index sheet	Pro/E P	DM: Rev:F	STATUS:Released	

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